Docket No. 248168US90CONT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Yasutaka ITO, et al.

SERIAL NO: NEW APPLICATION

FILED: HEREWITH

FOR: CERAMIC HEATER

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- Attached is a list of applicant's pending application(s) or issued patent(s) which may be related to the present application. A copy of the patent(s), together with a copy of the claims and drawings of the pending application(s) is attached along with PTO 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- □ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number <u>15-0030</u>. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, MoCLELLAND, MAIER & NEUSTADT, P.C.

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22850

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Harris A. Pitlick

Registration No. 38,779

			ATTY DOCKET NO.		SERIAL NO.			
(Modified)		PATENT AND TRA	DEMARK OFFICE	248168US90CONT		NEW APPLICATION		
			APPLICANT					
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	AX							
	AY							
	ΑZ				Addit	tional Refe	rences s	sheet(s) attached
Examiner					Date Considered			
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	AB	6,475,606	11/05/2002	Niwa				
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OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)								
	AW							
	AX							
	AY							
	AZ				Addi	tional Refe	erences sheet(s) attached	
Examiner				Date Considered				
*Examiner: In conformance	tial if re and no	eference is considered of considered. Include c	, whether or not opy of this form	citation is in conformance with MPEP 6 with next communication to applicant.	609; Draw lii	ne through	citation if not in	

LIST OF RELATED CASES

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PER CLIENT	10/345,356	01/16/03	ITO
PER CLIENT	09/787,818	03/23/01	ITO
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PER CLIENT	10/356,519	02/03/03	ITO
PER CLIENT	10/217,029	08/13/02	ITO
PER CLIENT	09/979,676	11/05/01	ZHOU
PER CLIENT	10/049,539	11/07/01	ZHOU
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PER CLIENT	10/182,009	07/24/02	ZHOU
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